



Date: February 9th, 2011

Subject: Product / Process Change Notification

Chip Tray / Process Notification Number

To Our Valued Customers:

Entegris Inc., is informing you that on February 22nd, we will be changing the packaging for H20 and H44 chip trays and covers (3" trays will not be included at this time). This change is being implemented to reduce the number of broken parts our customers receive. Cardboard sleeves will now be placed around the outside stacks of bagged chip trays (see photo examples below).

The following changes will be made:

1. Case quantities will be reduced in order to reduce the overall box weight.

Series	Current Case Qty	New Case Quantity
H20	3200	1600
H44	400	200

2. Minimum order quantities (MOQ) will change in order to accommodate the new packaging - A total of 1,600 2" trays will be placed per carton vs. 3,200, while 200 4" trays will be placed in a carton vs. 400.

Series	Current MOQ			New MOQ		
	Catalog	Non-Catalog Item	Non-Catalog Item (with Fee)	Catalog	Non-Catalog Item	Non-Catalog Item (with Fee)
H20	300	2,000	300	400	1,600	400
H44	200	1,000	200	No Change	No Change	No Change

3. Packaging size:

Series	Current Box	New Box
H20	16.5" x 11.25" x 8.25"	14.24" x 9.75" x 9.5"

4. Average Package Weight::

Series	Current Box	New Box
H20	48 lbs	24Lbs
H44	32 lbs	14 lbs

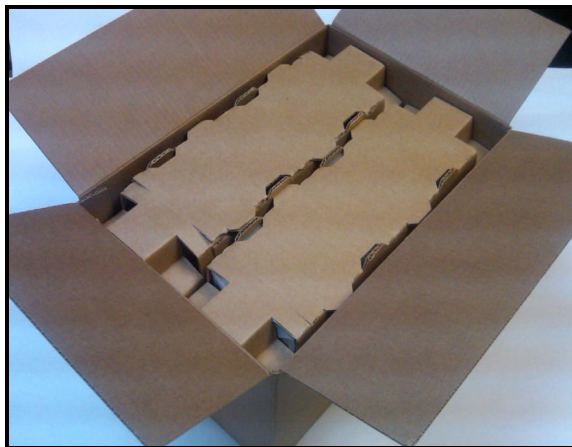
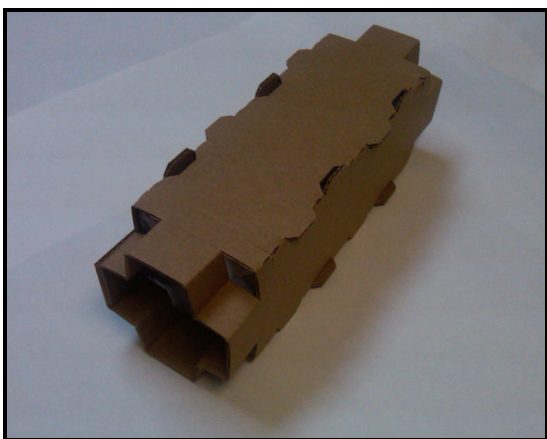
5. Labels – One product label will be placed on the outside of the shipping container.



H20 Series (400 per cardboard sleeve)



H44 Series (50 parts per cardboard sleeve)



4 cardboard sleeves per box

Sincerely

Doug Moser, LH Say Product Manager Finished Wafer / Backend Products